

FORM PTO-1449 (Modified)		ATTY. DOCKET NO. 2003-IP-011752U1	SERIAL NO. unknown
LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT		APPLICANT Jiten Chatterji et al.	
(Use several sheets if necessary)		FILING DATE concurrently herewith	GROUP Unknown

## U.S. PATENT DOCUMENTS

EXAMINER INITIAL		Document No.	Date	Name	Class	Subclass	Filing Date if Appropriate
GW	AA	Re. 32,302	12/09/86	Almond et al.	166	308	
	AB	4,480,696	11/06/84	Almond et al.	166	308	
	AC	4,627,495	12/09/86	Harris et al.	166	280	
	AD	4,664,851	05/12/87	Drent	260	410.9 R	
	AE	4,809,783	03/07/89	Hollenbeck et al.	166	307	
	AF	5,373,901	12/20/94	Norman et al.	166	300	
	AG	5,604,186	02/18/97	Hunt et al.	507	204	
	AH	5,990,052	11/23/99	Harris	507	214	
	AI	6,357,527 B1	03/19/02	Norman et al.	166	300	
✓	AJ	6,454,008 B1	09/24/02	Chatterji et al.	166	308	
	AK	6,460,632 B1	10/08/02	Chatterji et al.	175	66	

## FOREIGN PATENT DOCUMENTS

		Document No.	Date	Country	Class	Subclass	Translation Yes   No
	AL						
	AM						
	AN						
	AO						
	AP						

## OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)

GW	AR	SPE 73730 entitled "High-pH Clay Instability Rating" by Rick Gdanski dated 2002.
✓	AS	SPE 64983 entitled "Impact of Clay Acidity on the pH of invading Fluids" by Rick Gdanski dated 2001.
✓	AT	<del>U.S. Patent Application Serial No. 10/062,342 entitled "Treatment of a Well with an Encapsulated Liquid and Process for Encapsulating a Liquid," inventors Matthew E. Blanch et al., filed February 1, 2002.</del>

EXAMINER

*GW*

DATE CONSIDERED

*1/21/05*

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

\* Cite U.S. applications for double patenting purposes only.

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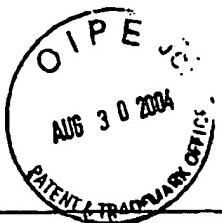
<i>JW</i>	AR	U.S. Patent Application Serial No. 10/396,606 entitled "Recyclable Foamed Fracturing Fluids and Methods of Using the Same," inventors Jiten Chatterji et al., filed March 25, 2003.
	AS	
	AT	

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Sheet 1 of 1

FORM PTO-1449 (Modified)		ATTY. DOCKET NO. 2003-IP-011752U1	SERIAL NO. 10/683,644
LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT			
(Use several sheets if necessary)		FILING DATE October 10, 2003	GROUP 3672

**U.S. PATENT DOCUMENTS**

EXAMINER INITIAL		Document No.	Date	Name	Class	Subclass	Filing Date if Appropriate
~lw	AA	6,729,408 B2	05/04/04	Hinkel et al.	166	308	
	AB						
	AC						
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	AH						
	AI						
	AJ						
	AK						

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